Robert Smith

Senior Embedded Software Engineer

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SUMMARY

Solid background in C/C++ programming for Embedded systems and Assembly languages. Knowledge of digital and analog hardware. Familiar with various Microcontroller architectures and functionality, including cross-platform development tools. Hands-on experience with RTOS. Proactive, result-oriented, self motivated team player with strong problem solving and organization skills. Flexible to handle change.

SKILLS

MS Office

WORK EXPERIENCE

Senior Embedded Software Engineer

Datron World Communications, Inc - March 2007 - 2020

- Developed C++ Embedded software for Software Defined Radio (SDR) using ColdFire microprocessor MCF6485 and MQX RTOS for High-Performance RT7700 HF Transceiver and HF Mobile Manpack PRC7700 Transceiver.
- Developed TRANSEC Frequency Hopping firmware controller for RT7700 and PRC7700.
- Developed PRC7700 ColdFire firmware controller to support 100W External Power Amplifier.
- Developed C++ Embedded software for Software Defined Radio (SDR) using ColdFire microprocessor MCF6485 and MQX.
- Developed PRC7700 ColdFire firmware controller for the internal Whip Antenna Tuner Developed ColdFire Battery Level Monitor and Low battery tone generation for PRC7700 Developed RT7700 ColdFire firmware controller to support 1kW/500W External HF Power Amplifier and 1kW Antenna Tuner.
- Developed firmware of the Control board of the 1kW/500W External Power Amplifier and 1kW Antenna Tuner using PIC microcontroller.
- Developed ColdFire UART based flash programming drivers for RapidM High Speed HF TC4 modem Developed Visual C++ small Windows Application to build ColdFire programming image for TC4 modem from RapidM TC4 DSP Application file.

Senior Embedded Software Engineer

Delta Corporation - 2004 - 2007

- Design and Develop the Kulicke and Soffa (KnS) new software control system for its next generations chip assembly bonder using UML2, C++, Java o .
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EDUCATION

Master of Science in Electronics Engineering - (Technical University of Sofia)